

RoHS Compliant Product

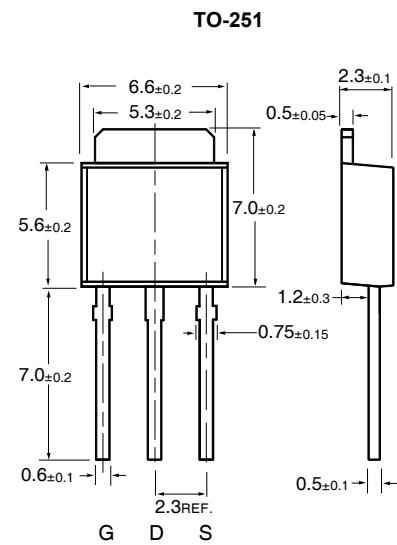
Description

The SID9971 provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

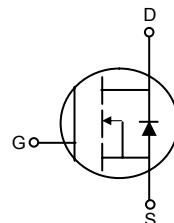
The TO-251 is universally preferred for all commercial-industrial surface mount applications and suited for low voltage applications such as DC/DC converters.

Features

- * Low On-Resistance
- * Simple Drive Requirement



Dimensions in millimeters



**Marking Code: 9971
XXXX(Date Code)**

Absolute Maximum Ratings

Parameter	Symbol	Ratings	Unit
Drain-Source Voltage	V_{DS}	60	V
Gate-Source Voltage	V_{GS}	± 20	V
Continuous Drain Current, $V_{GS}=10V$	$I_D @ T_c=25^\circ C$	25	A
Continuous Drain Current, $V_{GS}=10V$	$I_D @ T_c=100^\circ C$	16	A
Pulsed Drain Current ¹	I_{DM}	80	A
Total Power Dissipation	$P_D @ T_c=25^\circ C$	39	W
Linear Derating Factor		0.31	W/ $^\circ C$
Operating Junction and Storage Temperature Range	T_j, T_{stg}	-55~+150	$^\circ C$

Thermal Data

Parameter	Symbol	Ratings	Unit
Thermal Resistance Junction-case	R_{thj-c}	3.2	$^\circ C/W$
Thermal Resistance Junction-ambient	R_{thj-a}	110	$^\circ C/W$

Electrical Characteristics(Tj=25°C Unless otherwise specified)

Parameter	Symbol	Min.	Typ.	Max.	Unit	Test Condition
Drain-Source Breakdown Voltage	BVDSS	60	—	—	V	VGS=0V, ID=250uA
Breakdown Voltage Temp. Coefficient	ΔBVDS/ΔTj	—	0.05	—	V/°C	Reference to 25°C, ID=1mA
Gate Threshold Voltage	VGS(th)	1.0	—	3.0	V	VDS=VGS, ID=250uA
Gate-Source Leakage Current	IGSS	—	—	±100	nA	VGS=±20V
Drain-Source Leakage Current (Tj=25°C)	IDSS	—	—	1	uA	VDS=60V, VGS=0
Drain-Source Leakage Current(Tj=150°C)		—	—	25	uA	VDS=48V, VGS=0
Static Drain-Source On-Resistance	RDS(ON)	—	—	36	mΩ	VGS=10V, ID=18A
		—	—	50		VGS=4.5V, ID=12A
Total Gate Charge ²	Qg	—	18	30	nC	Id=18A VDS=48V VGS= 4.5V
Gate-Source Charge	Qgs	—	6	—		
Gate-Drain ("Miller") Charge	Qgd	—	11	—		
Turn-on Delay Time ²	TD(on)	—	9	—	nS	VDD=30V Id=18A VGS=10V RG=3.3Ω RD=1.67Ω
Rise Time	Tr	—	24	—		
Turn-off Delay Time	TD(off)	—	26	—		
Fall Time	Tf	—	7	—		
Input Capacitance	Ciss	—	1700	2700	pF	VGS=0V VDS=25V f=1.0MHz
Output Capacitance	Coss	—	160	—		
Reverse Transfer Capacitance	Crss	—	110	—		
Forward Transconductance	Gfs	—	17	—	S	VDS=10V, Id=18A

Source-Drain Diode

Parameter	Symbol	Min.	Typ.	Max.	Unit	Test Condition
Forward On Voltage ²	VSD	—	—	1.2	V	Is=25 A, VGS=0V.
Reverse Recovery Time	Trr	—	37	—	nS	Is=18A, VGS=0V. dI/dt=100A/us
Reverse Recovery Change	Qrr	—	38	—		

Notes: 1.Pulse width limited by safe operating area.

2.Pulse width≤300us, dutycycle≤2%.

SECOs

Elektronische Bauelemente

SID9971

25A, 60V, RDS(ON)36 mΩ

N-Channel Enhancement Mode Power Mos.FET

Characteristics Curve

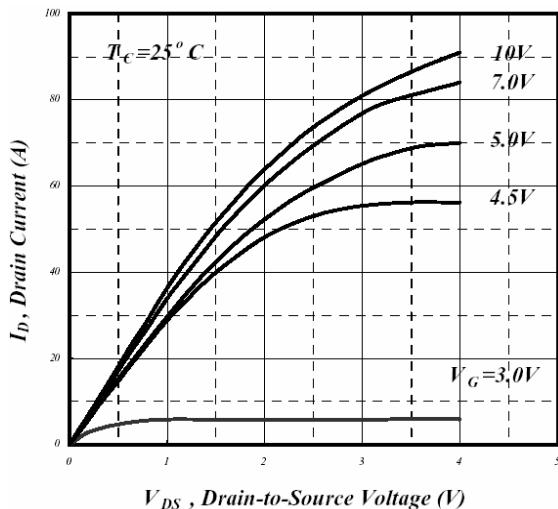


Fig 1. Typical Output Characteristics

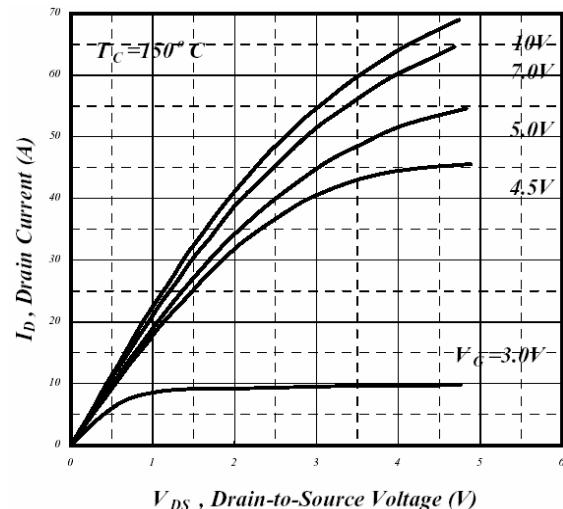


Fig 2. Typical Output Characteristics

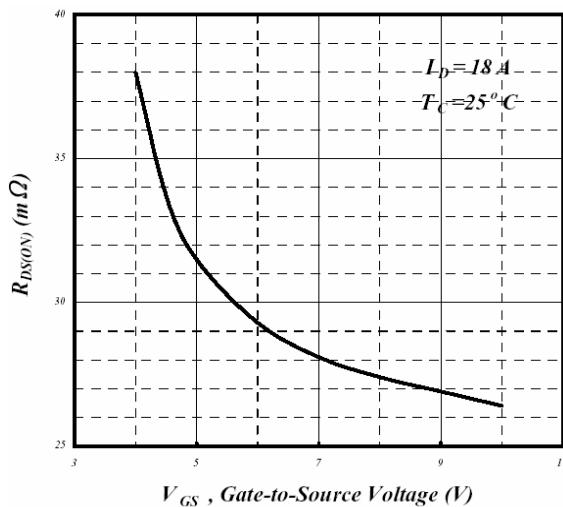


Fig 3. On-Resistance v.s. Gate Voltage

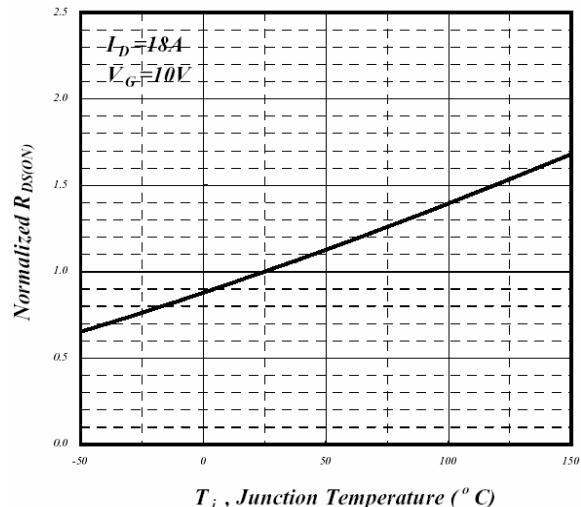


Fig 4. Normalized On-Resistance v.s. Junction Temperature

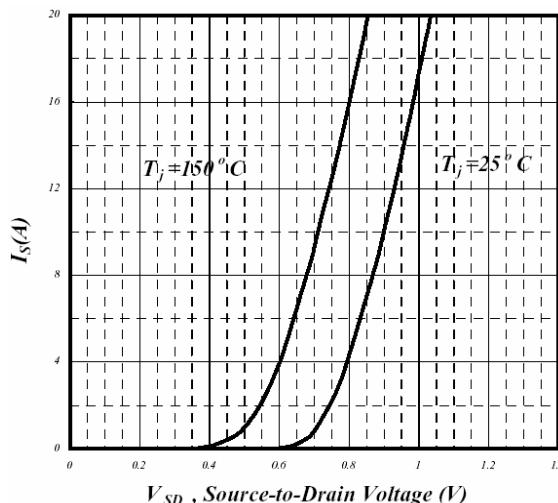


Fig 5. Forward Characteristics of Reverse Diode

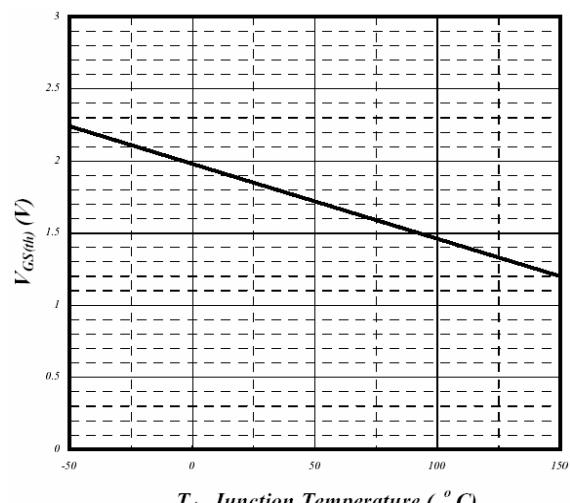


Fig 6. Gate Threshold Voltage v.s. Junction Temperature

Any changing of specification will not be informed individual

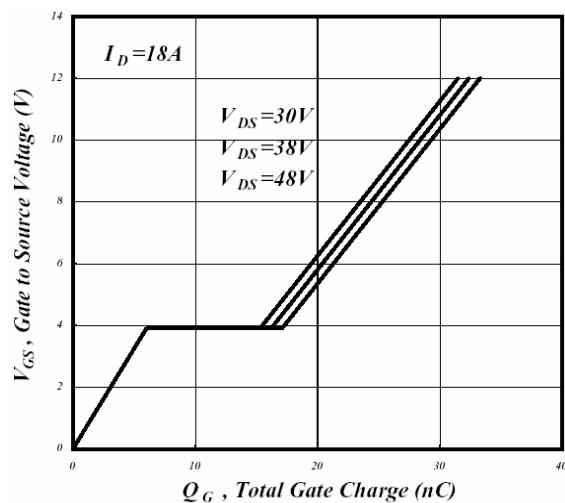


Fig 7. Gate Charge Characteristics

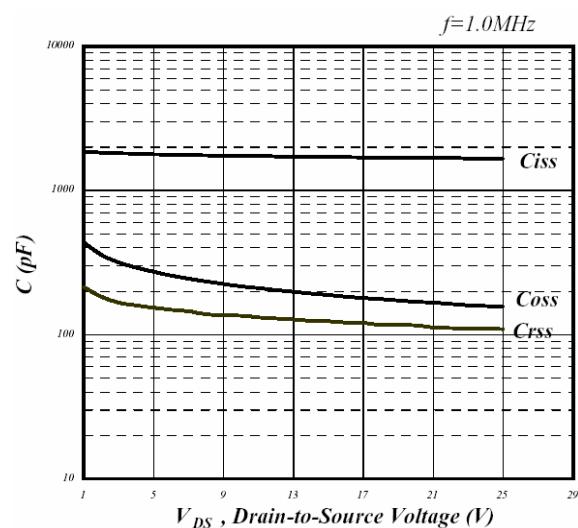


Fig 8. Typical Capacitance Characteristics

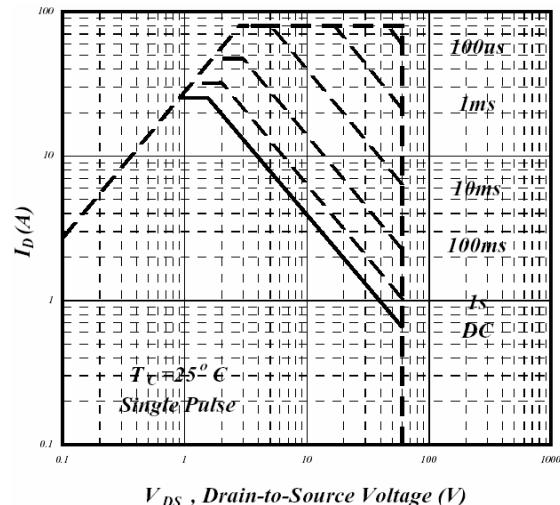


Fig 9. Maximum Safe Operating Area

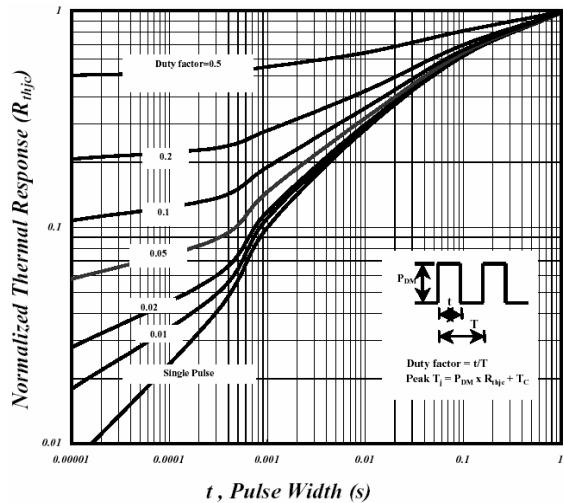


Fig 10. Effective Transient Thermal Impedance

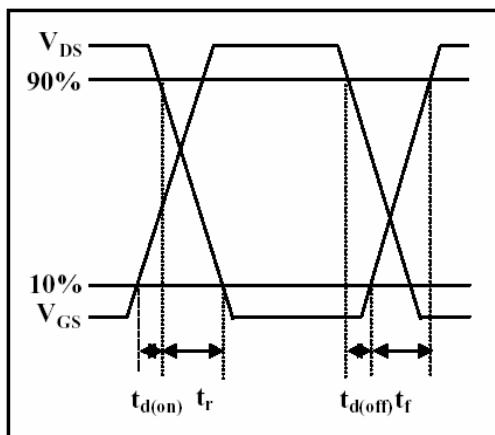


Fig 11. Switching Time Waveform

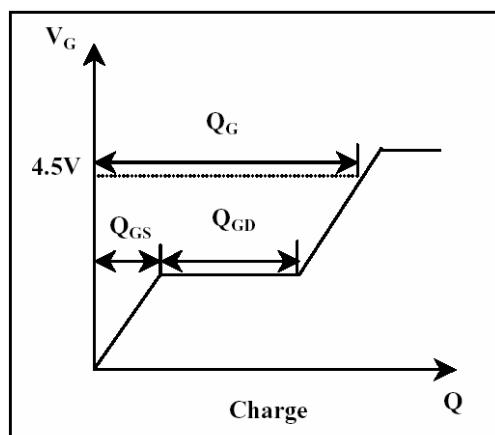


Fig 12. Gate Charge Waveform